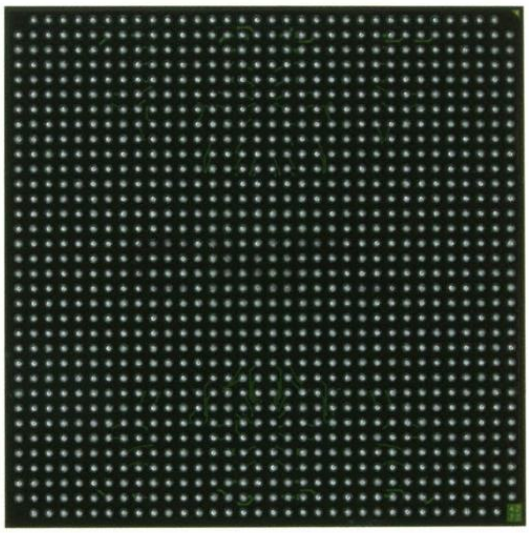

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	11648
Number of Logic Elements/Cells	-
Total RAM Bits	3096576
Number of I/O	824
Number of Gates	8000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v8000-4ffg1152c

Table 1: **Virtex-II Field-Programmable Gate Array Family Members**

Device	System Gates	CLB (1 CLB = 4 slices = Max 128 bits)			Multiplier Blocks	SelectRAM Blocks		DCMs	Max I/O Pads(1)
		Array Row x Col.	Slices	Maximum Distributed RAM Kbits		18 Kbit Blocks	Max RAM (Kbits)		
XC2V40	40K	8 x 8	256	8	4	4	72	4	88
XC2V80	80K	16 x 8	512	16	8	8	144	4	120
XC2V250	250K	24 x 16	1,536	48	24	24	432	8	200
XC2V500	500K	32 x 24	3,072	96	32	32	576	8	264
XC2V1000	1M	40 x 32	5,120	160	40	40	720	8	432
XC2V1500	1.5M	48 x 40	7,680	240	48	48	864	8	528
XC2V2000	2M	56 x 48	10,752	336	56	56	1,008	8	624
XC2V3000	3M	64 x 56	14,336	448	96	96	1,728	12	720
XC2V4000	4M	80 x 72	23,040	720	120	120	2,160	12	912
XC2V6000	6M	96 x 88	33,792	1,056	144	144	2,592	12	1,104
XC2V8000	8M	112 x 104	46,592	1,456	168	168	3,024	12	1,108

Notes:
1. See details in Table 2, "Maximum Number of User I/O Pads".

General Description

The Virtex-II family is a platform FPGA developed for high performance from low-density to high-density designs that are based on IP cores and customized modules. The family delivers complete solutions for telecommunication, wireless, networking, video, and DSP applications, including PCI, LVDS, and DDR interfaces.

The leading-edge 0.15 µm / 0.12 µm CMOS 8-layer metal process and the Virtex-II architecture are optimized for high speed with low power consumption. Combining a wide variety of flexible features and a large range of densities up to 10 million system gates, the Virtex-II family enhances programmable logic design capabilities and is a powerful alternative to mask-programmed gates arrays. As shown in Table 1, the Virtex-II family comprises 11 members, ranging from 40K to 8M system gates.

Packaging

Offerings include ball grid array (BGA) packages with 0.80 mm, 1.00 mm, and 1.27 mm pitches. In addition to traditional wire-bond interconnects, flip-chip interconnect is used in some of the BGA offerings. The use of flip-chip interconnect offers more I/Os than is possible in wire-bond versions of the similar packages. Flip-chip construction offers the combination of high pin count with high thermal capacity.

Wire-bond packages CS, FG, and BG are optionally availabe in Pb-free versions CSG, FGG, and BGG. See Virtex-II Ordering Examples, page 6.

Table 2 shows the maximum number of user I/Os available. The Virtex-II device/package combination table (Table 6 at the end of this section) details the maximum number of I/Os for each device and package using wire-bond or flip-chip technology.

Table 2: **Maximum Number of User I/O Pads**

Device	Wire-Bond	Flip-Chip
XC2V40	88	-
XC2V80	120	-
XC2V250	200	-
XC2V500	264	-
XC2V1000	328	432
XC2V1500	392	528
XC2V2000	-	624
XC2V3000	516	720
XC2V4000	-	912
XC2V6000	-	1,104
XC2V8000	-	1,108

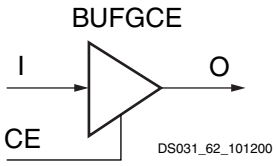

Figure 42: **Virtex-II BUFGCE Function**

If the CE input is inactive (Low) prior to the incoming rising clock edge, the following clock pulse does not pass through the clock buffer, and the output stays Low. Any level change of CE during the incoming clock High time has no effect. CE must not change during a short setup window just prior to the rising clock edge on the BUFGCE input I. Violating this setup time requirement can result in an undefined runt pulse output.

BUFGMUX

BUFGMUX can switch between two unrelated, even asynchronous clocks. Basically, a Low on S selects the I0 input, a High on S selects the I1 input. Switching from one clock to the other is done in such a way that the output High and Low time is never shorter than the shortest High or Low time of either input clock. As long as the presently selected clock is High, any level change of S has no effect .

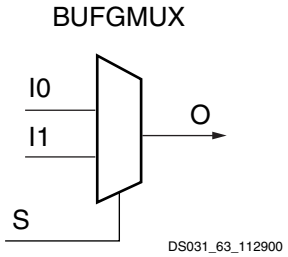

Figure 43: **Virtex-II BUFGMUX Function**

If the presently selected clock is Low while S changes, or if it goes Low after S has changed, the output is kept Low until the other ("to-be-selected") clock has made a transition from High to Low. At that instant, the new clock starts driving the output.

The two clock inputs can be asynchronous with regard to each other, and the S input can change at any time, except for a short setup time prior to the rising edge of the presently selected clock (I0 or I1). Violating this setup time requirement can result in an undefined runt pulse output.

All Virtex-II devices have 16 global clock multiplexer buffers.

Figure 44 shows a switchover from I0 to I1.

- The current clock is CLK0.
- S is activated High.
- If CLK0 is currently High, the multiplexer waits for CLK0 to go Low.
- Once CLK0 is Low, the multiplexer output stays Low until CLK1 transitions High to Low.
- When CLK1 transitions from High to Low, the output switches to CLK1.
- No glitches or short pulses can appear on the output.

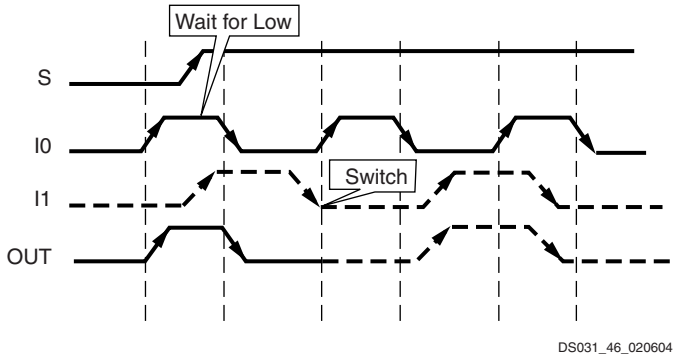

Figure 44: **Clock Multiplexer Waveform Diagram**

Local Clocking

In addition to global clocks, there are local clock resources in the Virtex-II devices. There are more than 72 local clocks in the Virtex-II family. These resources can be used for many different applications, including but not limited to memory interfaces. For example, even using only the left and right I/O banks, Virtex-II FPGAs can support up to 50 local clocks for DDR SDRAM. These interfaces can operate beyond 200 MHz on Virtex-II devices.

Digital Clock Manager (DCM)

The Virtex-II DCM offers a wide range of powerful clock management features.

- **Clock De-skew**: The DCM generates new system clocks (either internally or externally to the FPGA), which are phase-aligned to the input clock, thus eliminating clock distribution delays.
- **Frequency Synthesis**: The DCM generates a wide range of output clock frequencies, performing very flexible clock multiplication and division.
- **Phase Shifting**: The DCM provides both coarse phase shifting and fine-grained phase shifting with dynamic phase shift control.

The DCM utilizes fully digital delay lines allowing robust high-precision control of clock phase and frequency. It also utilizes fully digital feedback systems, operating dynamically to compensate for temperature and voltage variations during operation.

Up to four of the nine DCM clock outputs can drive inputs to global clock buffers or global clock multiplexer buffers simultaneously (see Figure 45). All DCM clock outputs can simultaneously drive general routing resources, including routes to output buffers.

Table 27: **Enhanced Pipelined Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Setup and Hold Times Before/After Clock					
Data Inputs	$T_{MULIDCK}/T_{MULCKID}$	3.00/0.00	3.45/0.00	3.89/0.00	ns, Max
Clock Enable	$T_{MULIDCK\_CE}/T_{MULCKID\_CE}$	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Reset	$T_{MULIDCK\_RST}/T_{MULCKID\_RST}$	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Clock to Output Pin					
Clock to Pin 35	$T_{MULTCK1\_P35}$	3.05	3.25	3.74	ns, Max
Clock to Pin 34	$T_{MULTCK1\_P34}$	2.95	3.14	3.61	ns, Max
Clock to Pin 33	$T_{MULTCK1\_P33}$	2.85	3.04	3.49	ns, Max
Clock to Pin 32	$T_{MULTCK1\_P32}$	2.76	2.93	3.37	ns, Max
Clock to Pin 31	$T_{MULTCK1\_P31}$	2.66	2.82	3.25	ns, Max
Clock to Pin 30	$T_{MULTCK1\_P30}$	2.56	2.72	3.12	ns, Max
Clock to Pin 29	$T_{MULTCK1\_P29}$	2.47	2.61	3.00	ns, Max
Clock to Pin 28	$T_{MULTCK1\_P28}$	2.37	2.50	2.88	ns, Max
Clock to Pin 27	$T_{MULTCK1\_P27}$	2.27	2.40	2.75	ns, Max
Clock to Pin 26	$T_{MULTCK1\_P26}$	2.17	2.29	2.63	ns, Max
Clock to Pin 25	$T_{MULTCK1\_P25}$	2.08	2.18	2.51	ns, Max
Clock to Pin 24	$T_{MULTCK1\_P24}$	1.98	2.07	2.38	ns, Max
Clock to Pin 23	$T_{MULTCK1\_P23}$	1.88	1.97	2.26	ns, Max
Clock to Pin 22	$T_{MULTCK1\_P22}$	1.79	1.86	2.14	ns, Max
Clock to Pin 21	$T_{MULTCK1\_P21}$	1.69	1.75	2.02	ns, Max
Clock to Pin 20	$T_{MULTCK1\_P20}$	1.59	1.65	1.89	ns, Max
Clock to Pin 19	$T_{MULTCK1\_P19}$	1.50	1.54	1.77	ns, Max
Clock to Pin 18	$T_{MULTCK1\_P18}$	1.40	1.43	1.65	ns, Max
Clock to Pin 17	$T_{MULTCK1\_P17}$	1.30	1.33	1.52	ns, Max
Clock to Pin 16	$T_{MULTCK1\_P16}$	1.20	1.22	1.40	ns, Max
Clock to Pin 15	$T_{MULTCK1\_P15}$	1.11	1.11	1.28	ns, Max
Clock to Pin 14	$T_{MULTCK1\_P14}$	1.01	1.00	1.15	ns, Max
Clock to Pin 13	$T_{MULTCK1\_P13}$	0.91	1.00	1.15	ns, Max
Clock to Pin 12	$T_{MULTCK1\_P12}$	0.91	1.00	1.15	ns, Max
Clock to Pin 11	$T_{MULTCK1\_P11}$	0.91	1.00	1.15	ns, Max
Clock to Pin 10	$T_{MULTCK1\_P10}$	0.91	1.00	1.15	ns, Max
Clock to Pin 9	$T_{MULTCK1\_P9}$	0.91	1.00	1.15	ns, Max
Clock to Pin 8	$T_{MULTCK1\_P8}$	0.91	1.00	1.15	ns, Max
Clock to Pin 7	$T_{MULTCK1\_P7}$	0.91	1.00	1.15	ns, Max
Clock to Pin 6	$T_{MULTCK1\_P6}$	0.91	1.00	1.15	ns, Max
Clock to Pin 5	$T_{MULTCK1\_P5}$	0.91	1.00	1.15	ns, Max
Clock to Pin 4	$T_{MULTCK1\_P4}$	0.91	1.00	1.15	ns, Max
Clock to Pin 3	$T_{MULTCK1\_P3}$	0.91	1.00	1.15	ns, Max
Clock to Pin 2	$T_{MULTCK1\_P2}$	0.91	1.00	1.15	ns, Max
Clock to Pin 1	$T_{MULTCK1\_P1}$	0.91	1.00	1.15	ns, Max
Clock to Pin 0	$T_{MULTCK1\_P0}$	0.91	1.00	1.15	ns, Max

Date	Version	Revision
07/30/01	1.6	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Added values to the Virtex-II Pin-to-Pin Output Parameter Guidelines and Virtex-II Pin-to-Pin Input Parameter Guidelines tables. • Added Frequency Synthesis table.
10/02/01	1.7	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Updated the speed grade designations used in data sheets, and added Table 13, which shows the current speed grade designation for each device.
10/05/01	1.8	• Corrected the speed grade designation for the XC2V1000 device in Table 13.
10/12/01	1.9	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.
11/28/01	2.0	• Updated values in Table 3, Table 4, Table 5, Virtex-II Performance Characteristics, and Virtex-II Switching Characteristics tables.
01/03/02	2.1	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.96**. • Changed the speed grade designation for the XC2V6000 device in Table 13.
07/16/02	2.2	• Updated values in Table 4, "Quiescent Supply Current." • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.111**. • Added Enhanced Multiplier Switching Characteristics section. • Added footnote to Table 37, "Global Clock Setup and Hold for LVTTL Standard, Without DCM." • Added Source-Synchronous Switching Characteristics section.
09/26/02	2.3	• Removed mention of MIL-M-38510/605 specification. • Added footnotes to Table 2 and Table 6.
12/06/02	2.4	• Revised SSTL2 values in Table 6 to match the latest JEDEC specification. • Added footnote regarding V_{IN} PCI compliance to Table 1. • Added footnote regarding CLKOUT_DUTY_CYCLE_DLL to Table 41.
05/07/03	2.5	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.114**. • Table 4, Quiescent Supply Current, and Table 5, Minimum Power On Current Required for Virtex-II Devices: Added parameters for XC2V8000 device. • Table 16, IOB Output Switching Characteristics: Changed parameter designator T_{IOTON} to T_{IOTP}. • Table 26, Enhanced Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULT\_P[nn]}$ to $T_{MULT1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Table 27, Enhanced Pipelined Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULTCK\_P[nn]}$ to $T_{MULTCK1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Removed old Table 19, **Standard Capacitive Loads**. • Added Figure 1, page 17, showing test configuration for measuring I/O standard adjustments.
06/19/03	2.5.1	• Removed footnotes in Table 34 and Table 36 that stated DCM jitter was included in the measurements.

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
6	IO_L46P_6	R2		
6	IO_L46N_6	R1		
6	IO_L48P_6	P6		
6	IO_L48N_6	P5		
6	IO_L49P_6	P4	NC	
6	IO_L49N_6	P3	NC	
6	IO_L51P_6	P2	NC	
6	IO_L51N_6/VREF_6	P1	NC	
6	IO_L52P_6	N6	NC	
6	IO_L52N_6	N5	NC	
6	IO_L54P_6	N4	NC	
6	IO_L54N_6	N3	NC	
6	IO_L91P_6	N2		
6	IO_L91N_6	N1		
6	IO_L93P_6	M6		
6	IO_L93N_6/VREF_6	M5		
6	IO_L94P_6	M4		
6	IO_L94N_6	M3		
6	IO_L96P_6	M2		
6	IO_L96N_6	M1		
7	IO_L96P_7	L2		
7	IO_L96N_7	L3		
7	IO_L94P_7	L4		
7	IO_L94N_7	L5		
7	IO_L93P_7/VREF_7	K1		
7	IO_L93N_7	K2		
7	IO_L91P_7	K3		
7	IO_L91N_7	K4		
7	IO_L54P_7	L6	NC	
7	IO_L54N_7	K6	NC	
7	IO_L52P_7	K5	NC	
7	IO_L52N_7	J5	NC	
7	IO_L51P_7/VREF_7	J1	NC	

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
5	IO_L02P_5/D7	AC6		
5	IO_L01N_5/RDWR_B	AB6		
5	IO_L01P_5/CS_B	AC5		
6	IO_L01P_6	AF2		
6	IO_L01N_6	AE1		
6	IO_L02P_6/VRN_6	AB4		
6	IO_L02N_6/VRP_6	AB3		
6	IO_L03P_6	AD2		
6	IO_L03N_6/VREF_6	AD1		
6	IO_L04P_6	AC2		
6	IO_L04N_6	AC1		
6	IO_L06P_6	AB2		
6	IO_L06N_6	AB1		
6	IO_L19P_6	AA4		
6	IO_L19N_6	AA3		
6	IO_L21P_6	Y6		
6	IO_L21N_6/VREF_6	Y5		
6	IO_L22P_6	W6		
6	IO_L22N_6	W7		
6	IO_L24P_6	AA2		
6	IO_L24N_6	AA1		
6	IO_L25P_6	Y4	NC	NC
6	IO_L25N_6	Y3	NC	NC
6	IO_L43P_6	W5		
6	IO_L43N_6	W4		
6	IO_L45P_6	W2		
6	IO_L45N_6/VREF_6	W3		
6	IO_L46P_6	Y1		
6	IO_L46N_6	W1		
6	IO_L48P_6	V6		
6	IO_L48N_6	V7		
6	IO_L49P_6	V5		
6	IO_L49N_6	V4		
6	IO_L51P_6	V3		
6	IO_L51N_6/VREF_6	V2		
6	IO_L52P_6	V1		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	DONE	AD22		
NA	M0	AD4		
NA	M1	AA5		
NA	M2	AD5		
NA	HSWAP_EN	D5		
NA	TCK	E21		
NA	TDI	F5		
NA	TDO	F22		
NA	TMS	D22		
NA	PWRDWN_B	AD23		
NA	DXN	F7		
NA	DXP	C5		
NA	VBATT	C23		
NA	RSVD	C22		
NA	VCCAUX	AD13		
NA	VCCAUX	AC24		
NA	VCCAUX	AC3		
NA	VCCAUX	P24		
NA	VCCAUX	N3		
NA	VCCAUX	D24		
NA	VCCAUX	D3		
NA	VCCAUX	C14		
NA	VCCINT	W19		
NA	VCCINT	W8		
NA	VCCINT	V18		
NA	VCCINT	V17		
NA	VCCINT	V10		
NA	VCCINT	V9		
NA	VCCINT	U18		
NA	VCCINT	U9		
NA	VCCINT	K18		
NA	VCCINT	K9		
NA	VCCINT	J18		
NA	VCCINT	J17		
NA	VCCINT	J10		
NA	VCCINT	J9		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	IO_L46P_7	H2		
7	IO_L46N_7	G2		
7	IO_L45P_7/VREF_7	H3		
7	IO_L45N_7	H4		
7	IO_L43P_7	G3		
7	IO_L43N_7	G4		
7	IO_L24P_7	H5		
7	IO_L24N_7	H6		
7	IO_L22P_7	J6		
7	IO_L22N_7	J7		
7	IO_L21P_7/VREF_7	K7		
7	IO_L21N_7	K8		
7	IO_L19P_7	E1		
7	IO_L19N_7	E2		
7	IO_L06P_7	D2		
7	IO_L06N_7	D3		
7	IO_L04P_7	E3		
7	IO_L04N_7	E4		
7	IO_L03P_7/VREF_7	F4		
7	IO_L03N_7	F5		
7	IO_L02P_7/VRN_7	G5		
7	IO_L02N_7/VRP_7	G6		
7	IO_L01P_7	H7		
7	IO_L01N_7	J8		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	J10		
0	VCCO_0	F11		
0	VCCO_0	C6		
0	VCCO_0	B11		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	J13		
1	VCCO_1	F14		
1	VCCO_1	C19		

BG728/BGG728 Standard BGA Package

As shown in Table 10, XC2V3000 Virtex-II devices are available in the BG728/BGG728 BGA package. Following this table are the BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch).

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
0	IO_L01N_0	B3
0	IO_L01P_0	A3
0	IO_L02N_0	B4
0	IO_L02P_0	A4
0	IO_L03N_0/VRP_0	C5
0	IO_L03P_0/VRN_0	C6
0	IO_L04N_0/VREF_0	B5
0	IO_L04P_0	A5
0	IO_L05N_0	E6
0	IO_L05P_0	D6
0	IO_L06N_0	B6
0	IO_L06P_0	A6
0	IO_L19N_0	E7
0	IO_L19P_0	D8
0	IO_L21N_0	F8
0	IO_L21P_0/VREF_0	E8
0	IO_L22N_0	C7
0	IO_L22P_0	C8
0	IO_L24N_0	B7
0	IO_L24P_0	A7
0	IO_L25N_0	H9
0	IO_L25P_0	J9
0	IO_L27N_0	F9
0	IO_L27P_0/VREF_0	G9
0	IO_L28N_0	E9
0	IO_L28P_0	D9
0	IO_L30N_0	C9
0	IO_L30P_0	B9
0	IO_L49N_0	A8
0	IO_L49P_0	A9
0	IO_L51N_0	G10
0	IO_L51P_0/VREF_0	H10
0	IO_L52N_0	F10

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	T13		
NA	GND	T12		
NA	GND	R19		
NA	GND	R18		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		
NA	GND	R12		
NA	GND	P24		
NA	GND	P19		
NA	GND	P18		
NA	GND	P17		
NA	GND	P16		
NA	GND	P15		
NA	GND	P14		
NA	GND	P13		
NA	GND	P12		
NA	GND	P7		
NA	GND	N19		
NA	GND	N18		
NA	GND	N17		
NA	GND	N16		
NA	GND	N15		
NA	GND	N14		
NA	GND	N13		
NA	GND	N12		
NA	GND	M26		
NA	GND	M19		
NA	GND	M18		
NA	GND	M17		
NA	GND	M16		
NA	GND	M15		
NA	GND	M14		
NA	GND	M13		
NA	GND	M12		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
1	IO_L93P_1	F17	
1	IO_L92N_1	G16	
1	IO_L92P_1	G17	
1	IO_L91N_1	C16	
1	IO_L91P_1/VREF_1	C15	
1	IO_L84N_1	D14	NC
1	IO_L84P_1	D15	NC
1	IO_L83N_1	J17	NC
1	IO_L83P_1	K17	NC
1	IO_L82N_1	B17	NC
1	IO_L82P_1	A17	NC
1	IO_L81N_1/VREF_1	A15	NC
1	IO_L81P_1	B16	NC
1	IO_L80N_1	L17	NC
1	IO_L80P_1	L16	NC
1	IO_L79N_1	A13	NC
1	IO_L79P_1	A14	NC
1	IO_L78N_1	C13	
1	IO_L78P_1	C14	
1	IO_L77N_1	K16	
1	IO_L77P_1	K15	
1	IO_L76N_1	B13	
1	IO_L76P_1	B14	
1	IO_L75N_1/VREF_1	F15	
1	IO_L75P_1	G15	
1	IO_L74N_1	H15	
1	IO_L74P_1	H14	
1	IO_L73N_1	A11	
1	IO_L73P_1	A12	
1	IO_L72N_1	E13	
1	IO_L72P_1	E14	
1	IO_L71N_1	J15	
1	IO_L71P_1	J14	
1	IO_L70N_1	D12	
1	IO_L70P_1	D13	
1	IO_L69N_1/VREF_1	F14	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	IO_L02P_5/D7	AG25	
5	IO_L01N_5/RDWR_B	AL30	
5	IO_L01P_5/CS_B	AM31	
6	IO_L01P_6	AE24	
6	IO_L01N_6	AD25	
6	IO_L02P_6/VRN_6	AJ30	
6	IO_L02N_6/VRP_6	AH30	
6	IO_L03P_6	AL32	
6	IO_L03N_6/VREF_6	AK32	
6	IO_L04P_6	AF25	
6	IO_L04N_6	AE25	
6	IO_L05P_6	AJ31	
6	IO_L05N_6	AK31	
6	IO_L06P_6	AH29	
6	IO_L06N_6	AG29	
6	IO_L19P_6	AG26	
6	IO_L19N_6	AF26	
6	IO_L20P_6	AL33	
6	IO_L20N_6	AK33	
6	IO_L21P_6	AJ32	
6	IO_L21N_6/VREF_6	AH32	
6	IO_L22P_6	AG28	
6	IO_L22N_6	AF28	
6	IO_L23P_6	AG30	
6	IO_L23N_6	AF30	
6	IO_L24P_6	AF29	
6	IO_L24N_6	AE29	
6	IO_L25P_6	AF27	
6	IO_L25N_6	AE27	
6	IO_L26P_6	AL34	
6	IO_L26N_6	AK34	
6	IO_L27P_6	AE28	
6	IO_L27N_6/VREF_6	AD28	
6	IO_L28P_6	AE26	
6	IO_L28N_6	AD26	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AP33	
NA	GND	AP32	
NA	GND	AP27	
NA	GND	AP8	
NA	GND	AP3	
NA	GND	AP2	
NA	GND	AN34	
NA	GND	AN33	
NA	GND	AN20	
NA	GND	AN15	
NA	GND	AN2	
NA	GND	AN1	
NA	GND	AM34	
NA	GND	AM32	
NA	GND	AM25	
NA	GND	AM10	
NA	GND	AM3	
NA	GND	AM1	
NA	GND	AL31	
NA	GND	AL4	
NA	GND	AK30	
NA	GND	AK23	
NA	GND	AK12	
NA	GND	AK5	
NA	GND	AJ29	
NA	GND	AJ6	
NA	GND	AH28	
NA	GND	AH21	
NA	GND	AH14	
NA	GND	AH7	
NA	GND	AG34	
NA	GND	AG27	
NA	GND	AG8	
NA	GND	AG1	
NA	GND	AF19	
NA	GND	AF16	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L76P_0	C24		
0	IO_L77N_0	K22		
0	IO_L77P_0	K21		
0	IO_L78N_0	E22		
0	IO_L78P_0	E23		
0	IO_L79N_0	B23		
0	IO_L79P_0	B24		
0	IO_L80N_0	J22		
0	IO_L80P_0	J21		
0	IO_L81N_0	G21		
0	IO_L81P_0/VREF_0	G22		
0	IO_L82N_0	A23		
0	IO_L82P_0	A24		
0	IO_L83N_0	H22		
0	IO_L83P_0	H21		
0	IO_L84N_0	F21		
0	IO_L84P_0	F22		
0	IO_L91N_0/VREF_0	B21		
0	IO_L91P_0	B22		
0	IO_L92N_0	L20		
0	IO_L92P_0	M20		
0	IO_L93N_0	E21		
0	IO_L93P_0	D22		
0	IO_L94N_0/VREF_0	A21		
0	IO_L94P_0	A22		
0	IO_L95N_0/GCLK7P	H20		
0	IO_L95P_0/GCLK6S	J20		
0	IO_L96N_0/GCLK5P	C21		
0	IO_L96P_0/GCLK4S	D21		
1	IO_L96N_1/GCLK3P	F19		
1	IO_L96P_1/GCLK2S	F20		
1	IO_L95N_1/GCLK1P	H19		
1	IO_L95P_1/GCLK0S	H18		
1	IO_L94N_1	C19		
1	IO_L94P_1/VREF_1	C20		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L81P_2/VREF_2	U5		
2	IO_L82N_2	V2		
2	IO_L82P_2	U2		
2	IO_L83N_2	V8		
2	IO_L83P_2	W8		
2	IO_L84N_2	W7		
2	IO_L84P_2	V7		
2	IO_L91N_2	W1		
2	IO_L91P_2	V1		
2	IO_L92N_2	Y11		
2	IO_L92P_2	Y12		
2	IO_L93N_2	W4		
2	IO_L93P_2/VREF_2	V4		
2	IO_L94N_2	W2		
2	IO_L94P_2	W3		
2	IO_L95N_2	Y8		
2	IO_L95P_2	Y9		
2	IO_L96N_2	W5		
2	IO_L96P_2	W6		
3	IO_L96N_3	AB8		
3	IO_L96P_3	AA8		
3	IO_L95N_3	Y3		
3	IO_L95P_3	AA3		
3	IO_L94N_3	Y6		
3	IO_L94P_3	AA6		
3	IO_L93N_3/VREF_3	AB9		
3	IO_L93P_3	AA9		
3	IO_L92N_3	AA1		
3	IO_L92P_3	AB1		
3	IO_L91N_3	Y5		
3	IO_L91P_3	AA5		
3	IO_L84N_3	AB10		
3	IO_L84P_3	AA10		
3	IO_L83N_3	AA2		
3	IO_L83P_3	AB2		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L91P_4	AV18		
4	IO_L92N_4	AH20		
4	IO_L92P_4	AJ20		
4	IO_L93N_4	AR19		
4	IO_L93P_4	AT18		
4	IO_L94N_4/VREF_4	AW19		
4	IO_L94P_4	AW18		
4	IO_L95N_4/GCLK3S	AL20		
4	IO_L95P_4/GCLK2P	AM20		
4	IO_L96N_4/GCLK1S	AU19		
4	IO_L96P_4/GCLK0P	AT19		
5	IO_L96N_5/GCLK7S	AP21		
5	IO_L96P_5/GCLK6P	AP20		
5	IO_L95N_5/GCLK5S	AN21		
5	IO_L95P_5/GCLK4P	AN22		
5	IO_L94N_5	AU21		
5	IO_L94P_5/VREF_5	AU20		
5	IO_L93N_5	AR21		
5	IO_L93P_5	AR20		
5	IO_L92N_5	AM21		
5	IO_L92P_5	AM22		
5	IO_L91N_5	AW22		
5	IO_L91P_5/VREF_5	AW21		
5	IO_L85N_5	AV22	NC	NC
5	IO_L85P_5	AV21	NC	NC
5	IO_L84N_5	AT22		
5	IO_L84P_5	AT21		
5	IO_L83N_5	AL21		
5	IO_L83P_5	AL22		
5	IO_L82N_5	AW24		
5	IO_L82P_5	AW23		
5	IO_L81N_5/VREF_5	AR23		
5	IO_L81P_5	AR22		
5	IO_L80N_5	AK21		
5	IO_L80P_5	AK22		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	AR26		
NA	GND	AR14		
NA	GND	AR5		
NA	GND	AP34		
NA	GND	AP6		
NA	GND	AN33		
NA	GND	AN20		
NA	GND	AN7		
NA	GND	AM32		
NA	GND	AM23		
NA	GND	AM17		
NA	GND	AM8		
NA	GND	AL31		
NA	GND	AL9		
NA	GND	AK30		
NA	GND	AK20		
NA	GND	AK10		
NA	GND	AJ38		
NA	GND	AJ29		
NA	GND	AJ11		
NA	GND	AJ2		
NA	GND	AF35		
NA	GND	AF5		
NA	GND	AD23		
NA	GND	AD22		
NA	GND	AD21		
NA	GND	AD20		
NA	GND	AD19		
NA	GND	AD18		
NA	GND	AD17		
NA	GND	AC36		
NA	GND	AC32		
NA	GND	AC24		
NA	GND	AC23		
NA	GND	AC22		
NA	GND	AC21		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
0	IO_L92N_0	F17	
0	IO_L92P_0	F16	
0	IO_L93N_0	B18	
0	IO_L93P_0	B17	
0	IO_L94N_0/VREF_0	J17	
0	IO_L94P_0	J16	
0	IO_L95N_0/GCLK7P	E17	
0	IO_L95P_0/GCLK6S	E16	
0	IO_L96N_0/GCLK5P	A18	
0	IO_L96P_0/GCLK4S	A17	
1	IO_L96N_1/GCLK3P	C16	
1	IO_L96P_1/GCLK2S	C15	
1	IO_L95N_1/GCLK1P	H16	
1	IO_L95P_1/GCLK0S	H15	
1	IO_L94N_1	A15	
1	IO_L94P_1/VREF_1	A14	
1	IO_L93N_1	F15	
1	IO_L93P_1	F14	
1	IO_L92N_1	G15	
1	IO_L92P_1	G14	
1	IO_L91N_1	B15	
1	IO_L91P_1/VREF_1	B14	
1	IO_L78N_1	D15	
1	IO_L78P_1	E15	
1	IO_L77N_1	J15	
1	IO_L77P_1	K14	
1	IO_L76N_1	D14	
1	IO_L76P_1	D13	
1	IO_L75N_1/VREF_1	E14	
1	IO_L75P_1	E13	
1	IO_L74N_1	A13	
1	IO_L74P_1	A12	
1	IO_L73N_1	F13	
1	IO_L73P_1	F12	
1	IO_L72N_1	J14	
1	IO_L72P_1	J13	
1	IO_L71N_1	B13	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
3	IO_L50P_3	AB3	
3	IO_L49N_3	AB5	
3	IO_L49P_3	AC5	
3	IO_L48N_3	W9	
3	IO_L48P_3	Y9	
3	IO_L47N_3	AC1	
3	IO_L47P_3	AD1	
3	IO_L46N_3	AC3	
3	IO_L46P_3	AD3	
3	IO_L45N_3/VREF_3	Y8	
3	IO_L45P_3	AA8	
3	IO_L44N_3	AC2	
3	IO_L44P_3	AE2	
3	IO_L43N_3	AB7	
3	IO_L43P_3	AC7	
3	IO_L27N_3/VREF_3	Y10	NC
3	IO_L27P_3	AA10	NC
3	IO_L25N_3	AE1	NC
3	IO_L25P_3	AF1	NC
3	IO_L24N_3	AF2	
3	IO_L24P_3	AG2	
3	IO_L23N_3	AA9	
3	IO_L23P_3	AB9	
3	IO_L22N_3	AD4	
3	IO_L22P_3	AE4	
3	IO_L21N_3/VREF_3	AD5	
3	IO_L21P_3	AE5	
3	IO_L20N_3	AB8	
3	IO_L20P_3	AC8	
3	IO_L19N_3	AG1	
3	IO_L19P_3	AH1	
3	IO_L06N_3	AF4	
3	IO_L06P_3	AG4	
3	IO_L05N_3	AB10	
3	IO_L05P_3	AB11	
3	IO_L04N_3	AF3	
3	IO_L04P_3	AG3	
3	IO_L03N_3/VREF_3	AD6	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	GND	D10	
NA	GND	D16	
NA	GND	D22	
NA	GND	D28	
NA	GND	E5	
NA	GND	E27	
NA	GND	F6	
NA	GND	F26	
NA	GND	G7	
NA	GND	G13	
NA	GND	G16	
NA	GND	G19	
NA	GND	G25	
NA	GND	H2	
NA	GND	H8	
NA	GND	H24	
NA	GND	H30	
NA	GND	J9	
NA	GND	J23	
NA	GND	K4	
NA	GND	K16	
NA	GND	K28	
NA	GND	N7	
NA	GND	N25	
NA	GND	P14	
NA	GND	P15	
NA	GND	P16	
NA	GND	P17	
NA	GND	P18	
NA	GND	R14	
NA	GND	R15	
NA	GND	R16	
NA	GND	R17	
NA	GND	R18	
NA	GND	T1	
NA	GND	T4	
NA	GND	T7	
NA	GND	T10	